

TERMINATION SURFACE MOUNT 10 WATT



DATA SHEET

PART NUMBER: SMT1206ALNF

HEET 1 OF 1

EN 13-0794 03/06/2013

FEATURES

Low Profile Surface Mount

High Power Low VSWR

Ideal For Automated Assembly

00% Tested

APPLICATIONS

Mobile Networks

Broadcast

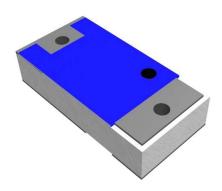
High Power Amplifiers

Instrumentation

Isolators

Military

Satellite Communications



GENERAL DESCRIPTION

EMC Technology's surface mount terminations are designed for direct installation on printed circuit boards and manufactured using thick film technology. Edge metallization on two sides forms the solder fillets for stronger attachment, easier inspection, and increased heat removal area. The devices are available in Alumina, Aluminum Nitride or Beryllium Oxide.

SPECIFICATIONS

1.0 ELECTRICAL

Nominal Impedance: 50Ω

Frequency Range: DC – 2.7 GHz VSWR: 1.25:1 Max

Temperature Coefficient: ±200 PPM/℃ Max

Power Rating: 10 Watts (Derating Chart)

DC Resistance: $50 \Omega \pm 5\%$

2.0 MECHANICAL

Substrate Aluminum Nitride

Resistive Film: Thick Film

Metallization: Thick Film, Silver Plated

3.0 UNIT MARKING

Input Dot

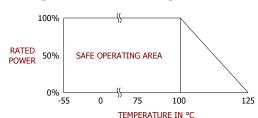
4.0 PACKAGING

Standard: Tape and Reel

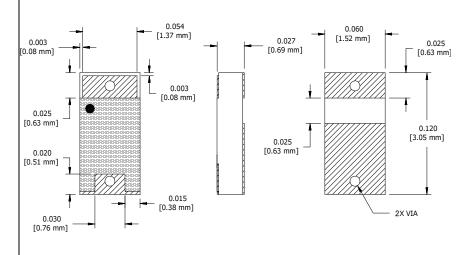
5.0 PART NUMBERING

Part Identifier: SMT1206ALNF

POWER RATING AND DERATING



MECHANICAL OUTLINE



Unless otherwise specified: TOLERANCE: ± .010

* Note: Specifications are subject to change without notice.

**NOTE: Power handling may vary depending on mounting and heat sinking method.

